

Data Sheet

August 1997

File Number

4268.2

14.4V Full Bridge Output Automotive 100W Subwoofer Amplifier

Description



The HIP100DCREF Reference Design is a 100W

RMS subwoofer amplifier, using Class-D topology, designed to operate from the 12V battery in automotive applications. The full bridge outputs are controlled by an HIP4081 MOSFET driver unique for audio applications. One hundred watt continuous RMS power is achieved through the use of low impedance speakers. The design is part of Intersil's CoolAudio program that enables Customers to achieve a minimum time-to-market for audio end products. The reference design's circular configuration is designed for mounting directly onto the back of a typical speaker thus insuring minimum conducted or radiated interference (EMI/RFI). The amplifier has been designed to run continuously at rated power with no droop in output level.

This design is offered to Customers after execution of a Licensing agreement. At this time, Intersil will provide a documentation package containing 1) Circuit Description, 2) Schematics, 3) Test and Manufacturing Information, 4) A Bill of Material with all vendor and vendor part numbers, 5) Intersil's Engineering Support Contacts, 6) One Sample Amplifier board.

For more information, see us on the web, home page http://www.intersil.com. For technical assistance, call Central Applications at 1-800-442-7747, or email us at centapp@intersil.com.

Features

- 14.4VDC Operation
- 20Hz to 900Hz Bandwidth (±3dB)
- 0.1% Typical THD+N at 100Hz and 100W RMS
- High Efficiency, Full Bridge Output (Typical >95% at 100W RMS)
- · Pop-Free Start-Up
- Remote On/Off
- · Variable Input Sensitivity

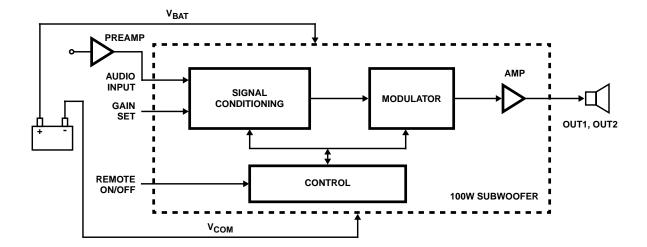
Applications

· Car Subwoofer Amplifier

Ordering Information

Contact Intersil licensing agents, Continental Far East or International Operations. See contact information provided

Reference Design Block Diagram



HIP100DCREF

Absolute Maximum Ratings

Operating Conditions

Supply Voltage, V _{BAT} (Note 1)0.3V to 27V	S
All Other Pin Voltages (Note 1) V _{GND} -0.3V to V _{BAT} +0.3V	V
OUT1, OUT2 Slew Rate	Te
Audio Input, J3	

Supply Voltage, V _{BAT} (Relative to GND)	. 13.7V to 14.4V
Voltage on V _{SS}	
Temperature Range	40°C to 60°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTES:

- 1. All voltages are relative to $\ensuremath{V_{GND}},$ unless otherwise specified.
- 2. $\theta_{\mbox{\scriptsize JA}}$ is measured with the component mounted on an evaluation PC board in free air.

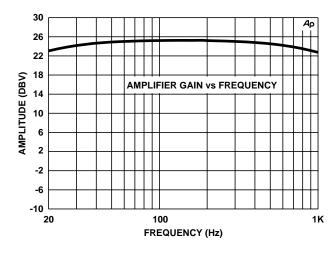
$\textbf{Electrical Specifications} \hspace{0.5cm} V_{BAT} = 14.4 \text{V}, \hspace{0.1cm} R_{LOAD} = 0.75 \Omega, \hspace{0.1cm} V_{COM} = 0 \text{V}$

			T _A = 25°C	
PARAMETER	SYMBOL	TEST CONDITIONS	TYP	UNITS
SUPPLY MEASUREMENTS				'
V _{BAT} Quiescent Current	I _{BATQ}	Audio In = 0V, Remote = V _{BAT} = 14.4V	200	mA
REM On/OFF Quiescent Current (On)	I _{REM}	REM = V _{BAT}	6	mA
V _{BAT} Idle Current	I _{BATIDLE}	Audio In = 0V, REM = V _{COM} = 0V	0.25	mA
PSRR (V _{OUT1} -V _{OUT2})/(V _{BAT2_1} -V _{BAT2_2})	P _{SRR}	V _{BAT} = 13 ±10%	3	mV/V
Minimum Battery Supply Voltage, Rising	V _{BATMINR}	REM = V _{BAT} , P _{OUT} = 25W	8.9	V
Minimum Battery Supply Voltage, Falling	V _{BATMINF}	REM = V _{BAT} , P _{OUT} = 25W	8.6	V
OUTPUT MEASUREMENTS				
Maximum Output Power	P _{MAX}	V _{BAT} = 14.4V	100	W
Efficiency	100WMAX _{EFF}	V _{BAT} = 14.4V at terminals of PC board	95	%
	50WMAX _{EFF}	POUT Measured at terminals of PC board	90	%
	10WMAX _{EFF}		80	%
PERFORMANCE MEASUREMENTS				
Total Harmonic Distortion + Noise	THD+N	P _{OUT} = 50W at 100Hz	0.08	%
SNR	V _{SNR}	Relative to Full Scale Output	-60	dB
PSSR (ΔV _{OUT} /ΔV _{BAT})	P _{SSR}	$V_{BAT} = \pm 1V$	3	mV/V
ADDITIONAL MEASUREMENTS				
Cutoff Frequency	F _{UPPER}		1000	Hz
Input Gain	I _{GAIN}	Measured at 100Hz	25.3	dB
Input Impedance	R _{IN}	Dependent upon setting of R ₁	3.3 to 10	kΩ

Reference Board Connector Assignment

SYMBOL	DESCRIPTION
REM	The remote on/off signal for the amplifier. Connect to the switched 12V of car or radio. JP1, Pin 2
V _{BAT}	The amplifier output stage power source. Connect through a fuse directly to the battery. JP2, Pin 1
OUT+	The + polarity high power output. JP2, Pin 2
OUT-	The -polarity high power output. JP2, Pin 1
V _{COM}	The ground return for the amplifier. JP1, Pin 3
Jack	Audio Input, J3

Typical Performance Curves



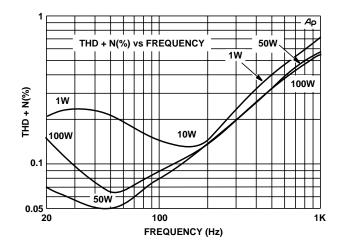


FIGURE 1. FREQUENCY RESPONSE

FIGURE 2. THD +N (%) vs FREQUENCY

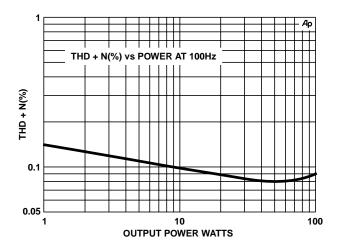
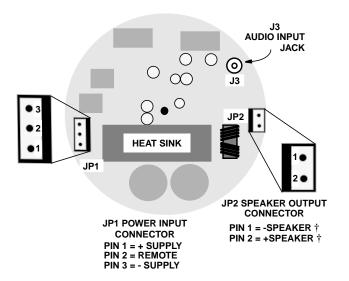
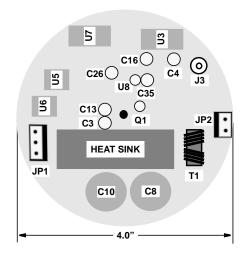


FIGURE 3. THD+N vs POWER

Reference Board Physical Layout





 $\ensuremath{\dagger}$ Damage will occur if either speaker lead is connected to ground.

FIGURE 4. AMPLIFIER CONNECTOR CONFIGURATION

FIGURE 5. AMPLIFIER DIMENSIONS AND LAYOUT



FIGURE 6. AMPLIFIER PHOTOGRAPH

HIP100DCREF

Electromagnetic Compatibility

FCC requirements for electromagnetic compatibility are meant to prevent one piece of equipment from generating noise which would interfere with another piece of equipment used in the same proximity. The requirements address both radiated emissions, noise transmitted though the air, and conducted emissions, noise transmitted through power and signal lines. Because the Intersil HIP100DCREF is designed for use in automotive applications, it qualifies as an exempted device under FCC regulations section 15.103. Additionally, the design has a clocking frequency below 1.705MHz, eliminating the FCC requirements for radiated emissions testing. Accordingly, any and all equipment built with the HIP100DCREF design will not need to be qualified to FCC requirements, unless other electronics are incorporated with clocking frequencies greater than 1.075MHz or it is used with residential power.

The question of electromagnetic compatibility is, however, still important. Some pieces of electronic equipment are more sensitive to electromagnetic noise than the FCC limits. Intersil has undertaken the responsibility to design this product to minimize interoperability problems with other equipment like FM receivers and TVs which may be used adjacent to the HIP100DCREF. Engineering testing has demonstrated emissions well below FCC limits and characterized sensitivity levels of other consumer electronic equipment.

The HIP100DCREF has been successfully tested to the limits of FCC Part 15 for digital devices operating in a residential environment. The European standards for the "Generic Limit, Residential" classification are comparable and reasonably correlate to the FCC limits. The radiated emissions were measured from 30MHz to 1000MHz at a distance of 3 meters with both horizontally and vertically polarized antennas and compared to the FCC limits below.

Frequency	Emission Limit
30MHz - 88MHz	$100\mu V = 40dBuV$
88MHz - 216MHz	$150\mu V = 43.5 dBuV$
216MHz - 960MHz	$200\mu V = 46dBuV$
960MHz - 1000MHz	$500\mu V = 54dBuV$

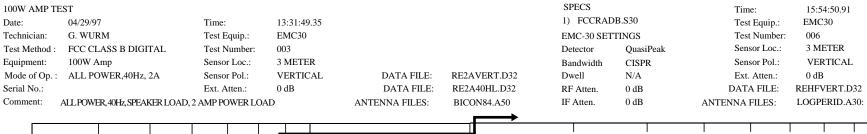
The European limits, measured at distance of 10 meters are:

Frequency	Emission Limit
30MHz - 230MHz	30μV/M
230MHz - 1000MHz	37μV/M

The emissions data presented in Figure 7 shows the worst case, vertical polarized antennas for the HIP100DCREF. Note two sets of data were combined to show this worst case condition from 30MHz to 1000MHz. Common data from each set of data is shown only once. Antenna data and file data is show above each segment, i.e., 30MHz to 200MHz and 200MHz to 1000MHz.

HIP100DCREF

Intersil Corporation



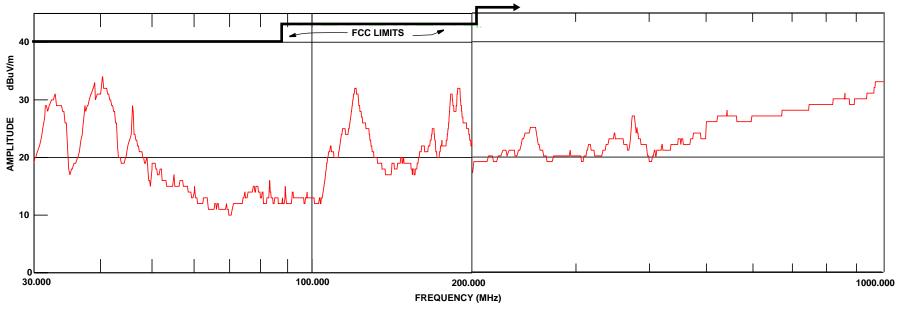


FIGURE 7. COMBINED EMI CURVES

Authorized Intersil Licensing Agents

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